"Co-creative Chemical Company"

- Reforms toward global top-level functional chemical company -

Hidehito Takahashi President & CEO Resonac Holdings Corporation February 14, 2024

Say & Do

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We will lead the semiconductor materials industry by realizing sustainable growth and revolutionizing the market

Say & Do

Aggressive investment in growing semiconductor materials business

Accelerate creation of co-creative innovations

Corporate culture reform & Human resource development

Say & Do

Agenda



2 Aggressive investment in growing semiconductor materials business

3 Accelerate creation of co-creative innovations



Corporate culture reform & Human resource development

Agenda



2 Aggressive investment in growing semiconductor materials business

3

Accelerate creation of co-creative innovations





Purpose The meaning of Resonac's existence

Change society through the power of chemistry

Contribute to the sustainable development of global society by creating functions required of the times as an advanced material partner

Values Our important values

Passionate & Results-Driven

Agile & Flexible

Open Minds & Open Connections

Solid Vision & Solid Integrity



Our vision: Resonac's ideals



Resonac's ideals

Co-creative chemical company

As a chemical company, we shall have first-class competency, decide and act quickly and flexibly, and co-create better society together with those who share the same aims with us, ranging from key players in the industrial circles to ordinary citizens.

Global top-level functional chemical company

We shall solve social problems by exerting our strong points we fostered as a Japanese chemical company and introducing advanced management method of global companies.

Corporate culture reform &

Human resource development

Resonac's long-term vision: Our ideals for 2030

Action 2

management resources

on semiconductor

materials business

Concentrate

2030

Our Vison

- Company that can compete on the world stage
- Company that contributes to a sustainable global society
- Company that develops co-creative human resources representing Japanese manufacturing industry

Main strategy to achieve Our Vision

Establish worldclass revenue base

Action 1

Establish CXO system

Portfolio reform

Improve business portfolio

Promote innovation

Strengthen business foundation

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3



Aggressive investment in growing semiconductor materials business

Accelerate creation of co-creative innovations





Approach to portfolio reform

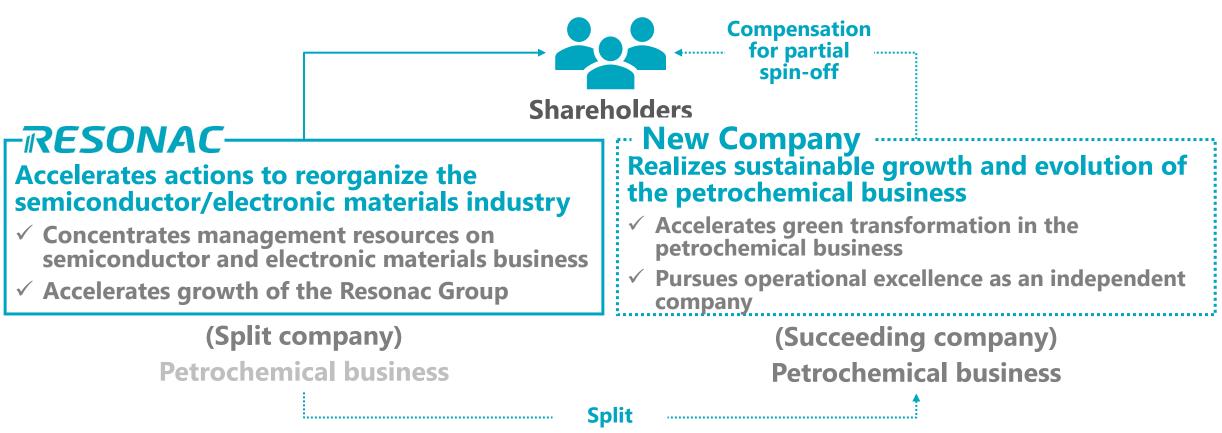


The road to optimum portfolio

	Shoko Co., Ltd. (Trading company: Sells chemicals, etc.) Aluminum can business					
	Food wrapping film business					
2021	Aluminum rolled products business					
	Printed wiring board business					
	Power storage device/system business					
2022	Ceramics business					
2022	ISOLITE (Insulating parts for cars, etc.)					
2023	Diagnostic agent business					
We have sold 9 businesses						

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Resonac Holdings has started to investigate partial spin-off of the Resonac Group's petrochemical business



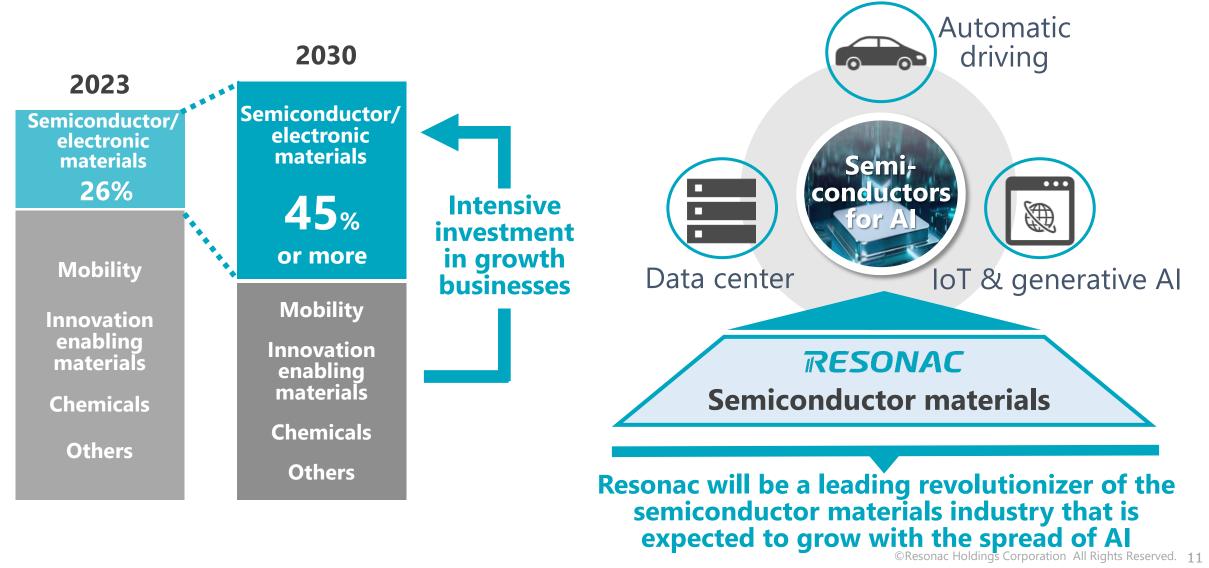
The timing of the execution of this spin-off has not been determined; however, REH will proceed with its assessment by the end of this year, giving consideration to executing this spin-off within the next two to three years. This assessment will include selection of the listing market and the possibility of satisfying relevant countries' taxqualification conditions including those of Japan and the United States. Execution of this spin-off is subject to approval and authorization from stakeholders and relevant authorities including stock exchanges. 10

We will make semiconductor materials business as our core business and realize groupwide increase in profits

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Nicely varied management resource allocation

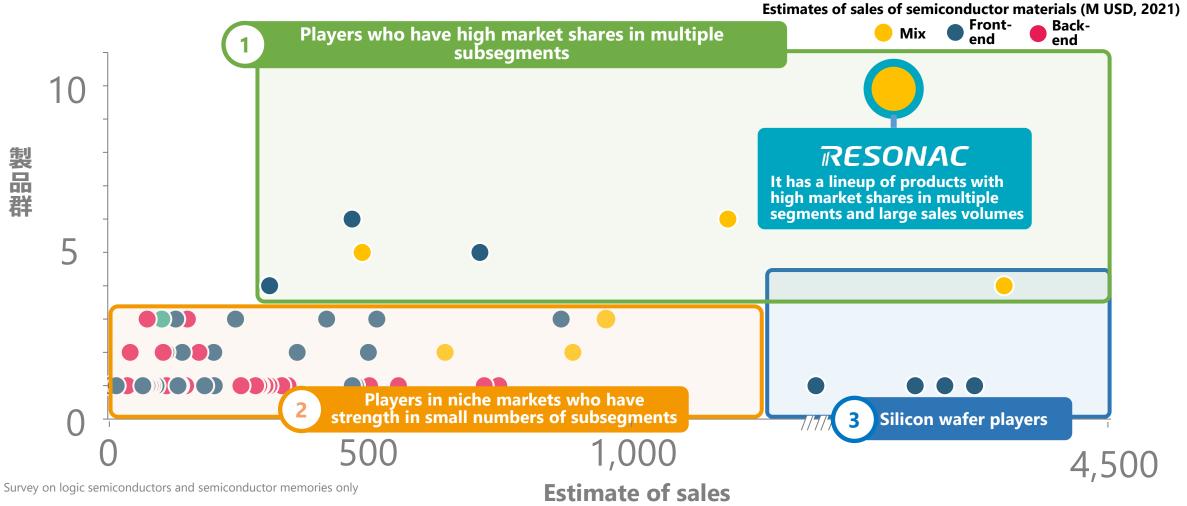
Resonac will specialize in semiconductor materials business that promises growth



Resonac is the leader of the semiconductor materials industry: Unique position and outstanding ability to make proposal to customers

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Resonac has a lineup of semiconductor materials that have high market shares in multiple segments, and can meet customers' needs in a flexible manner



Source: "Current situation of semiconductor materials market and outlook for it" published by Fuji Keizai Co., Ltd. in 2020 and 2022, BCG analysis for 2022

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Increase in data accelerates shift from independent designing of chips and parts to total package designing. Now semiconductor materials manufacturer's competitiveness comes from its ability to propose back-end materials, rather than its ability to innovate front-end materials.

Front-end (Form circuits on wafers)

Formation of circuit has already miniaturized to several nanometers. Miniaturization of circuit is now reaching the limit.

Back-end (Packaging of semiconductor chips)

Innovation in packaging attracts attention

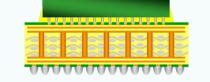
Higher integration of semiconductor chips requires sophisticated and complicated designing process Leading-edge package

Conventional package



Simple chip $\times 1$

Evaluation of single material



Highly integrated chip \times 1

Evaluation of combinations

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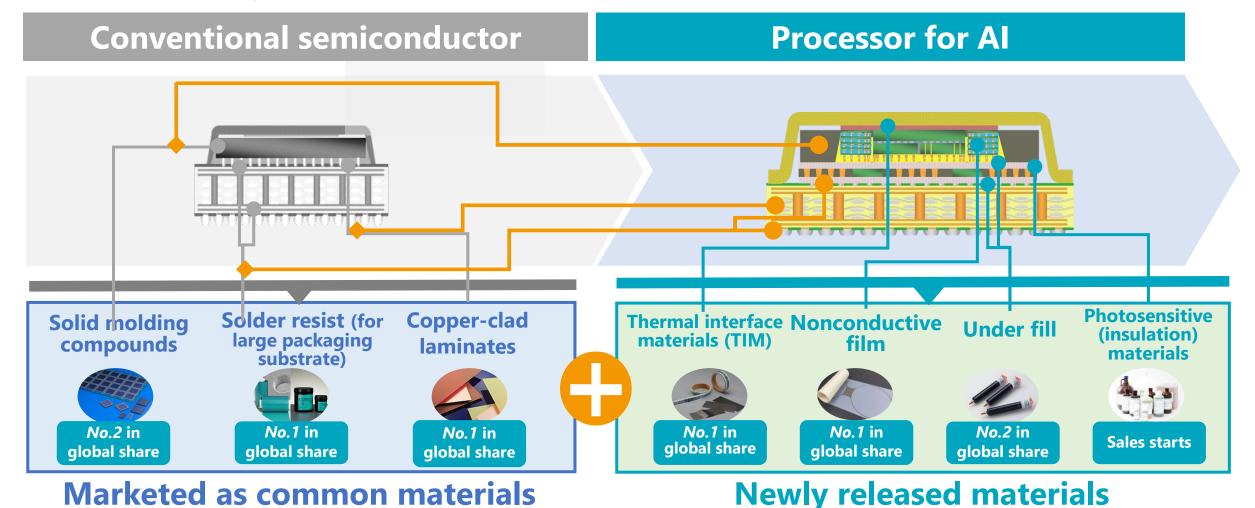
Highly integrated chips × **plural numbers**

Evaluation of total package

Resonac's semiconductor materials for AI processor and integrated solutions

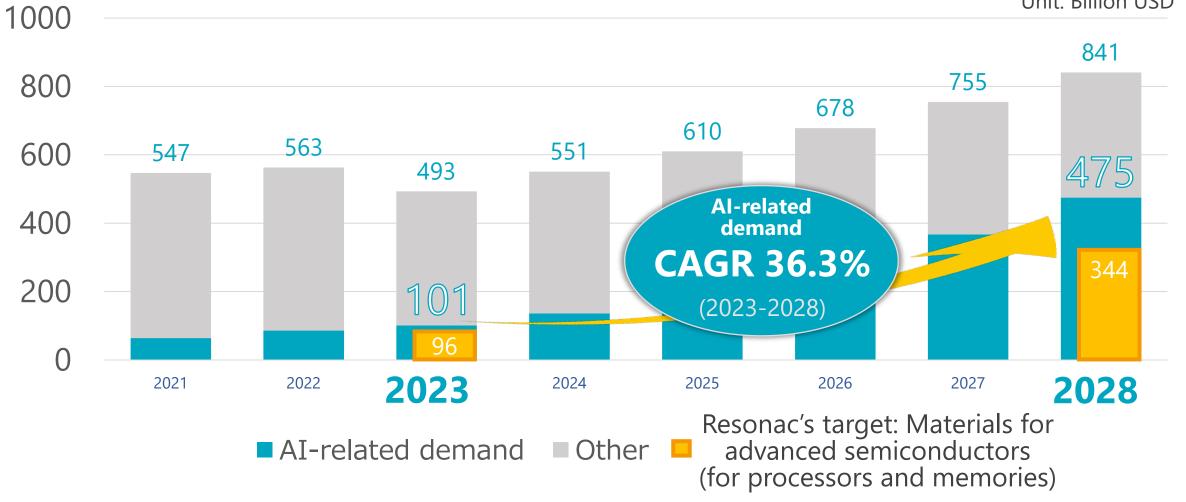
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On the basis of proven semiconductor materials, Resonac's semiconductor materials business continues growing due to a major increase in the demand for materials caused by increases in number of parts and size of semiconductors



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Semiconductor market has exited no-growth period and restarted to grow Toward 2028, the demand for AI processorswill lead the market growth



Designing of leading-edge semiconductors is concentrated in Silicon Valley. GAFAM are developing original chips optimized for generative AI in-house.

Supply chain of semiconductors for AI servers

Semi	conductor users	Semiconductor manufacturers					
Data cen	ter (for generative AI)	Design	Front-end	Back-end			
Google and Amazon develops Al processor in- house	Google Apple Meta	Intel AMD nVIDIA	Intel TSMC Samsung	Intel TSMC OSAT companies			
	Amazon Microsoft	GAFAM enter into the semiconductor industry					

Overseas strategy 1: Concept leader for leading-edge semiconductor package. Promotion of co-creation with device manufacturers

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Resonac plans to establish Packaging Solution Center in Silicon Valley, USA,

where GAFAM and semiconductor manufacturers are concentrated

We have started preparation work including investigation and research on equipment to be introduced

2024 Trial operation will be started2025 Full scale operation will be started



Overseas strategy 2: We will accelerate development of technologies for 2.xD and 3D semiconductor packaging

Resonac participates in Texas Institute for Electronics (TIE)*¹, a consortium to develop **leading-edge** semiconductor

where leading semiconductor manufacturers and semiconductor production equipment manufacturers of the United States gather

Resonac is the sole board member of TIE as semiconductor materials manufacturer, and is the first non-U.S. strategic partner of the consortium.*²

In the second half of 2024, prototype production line for 2.xD and 3D semiconductor packages will be started up

×1 TIE is a non-profit organization led by the University of Texas at Austin, and consists of the public and private sectors including the state of Texas, semiconductor manufacturers, defense electronics manufacturers, national laboratories, and academic bodies, *2: As of October 2023

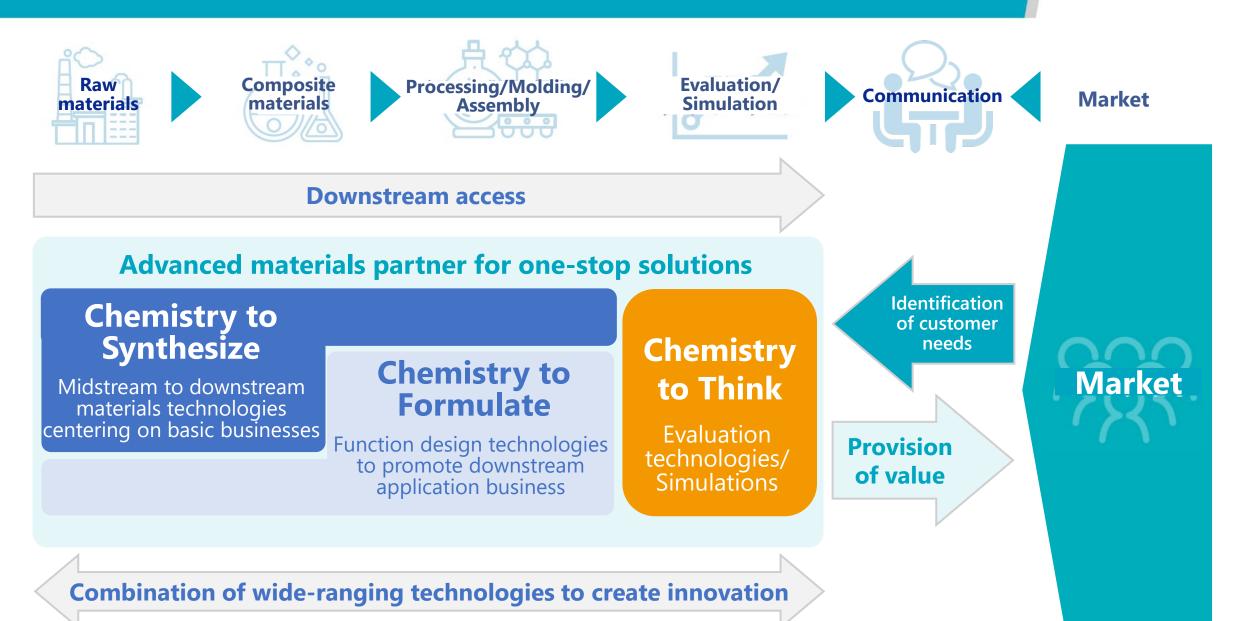
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- Accelerate creation of co-creative innovations

Corporate culture reform & Human resource development

Co-creative innovation value creation model



Accelerate creation of co-creative innovation through cooperation, deepening, and strengthening

Deepening

"Chemistry to Synthesize"

Cooperation between plants

on development and

Deepening development

of synthesized organic

materials

Design and

production

of resins

Design and

production of

monomers

Strengthening "Chemistry to Think"

Following customers who have leading technologies, production of Monomer/Resin we will develop evaluation technologies

Development

of evaluation

technologies

Power Module Integration Center

Platform to accelerate research and development

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Research Center for Computational Science and Informatics



Examples of cooperation to promote co-creative innovation

Functional Semiconductor materials materials

Cooperation between "synthesize" and "formulate"

Integration of R&D sections

will enhance functionality and

improve efficiency

Cooperative development

of filler and composite materials

Filler

Composite materials

Chemistry

to Formulate

Chemistry

to

Synthesize

Plant Plant

Semiconductor 5.9.5 materials

Analysis and Evaluation

Development

of materials

for power

modules

Semiconductor Computational materials science

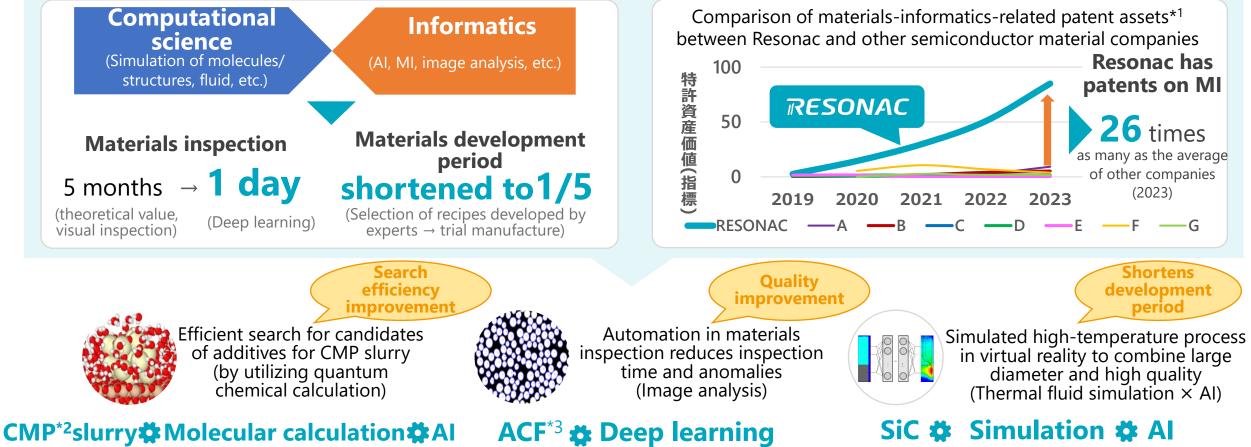
Innovation in technology for semiconductor materials supported by computational science and informatics

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World top-level patent assets give Resonac competitive advantage

Computational science and informatics revolutionize development of semiconductor materials Resonac opens a new dimension of co-creative innovation through rapid product development and overwhelming intellectual-property power





1 Patent assets: This amount is based on Data in LexisNexis' PatentSight® and Resonac's original estimate 2 CMP: Chemical mechanical polish *3 ACF: Anisotropic conductive film

Co-creation with other companies toward growth





Packaging Solution Center

Seeks to make technical innovations together with other companies

Stage for Co-creation

Base for open innovation functioning as the core of Resonac's R&D activities

Innovation Center

Communication space that gives birth to the seeds of co-creation

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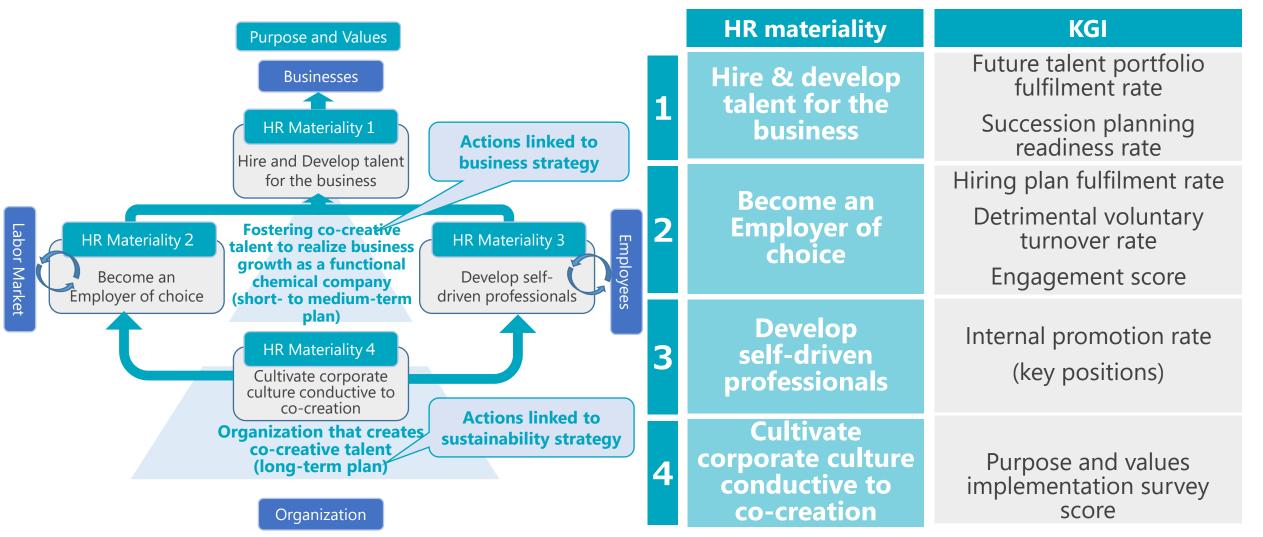




Each of us should personalize and practice Purpose and Values

Resonac's human resource strategy

Human resource materiality and KGI



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Through construction of global human resource management system, We will visualize human resources and their skills, realize dynamic human-resource portfolio management suitable for our business strategy, select core human resources early, and train them strategically.

2022		2023		2024		Ideal image of HR management
 Examined the system to select core HRs early Started to introduce talent 	Integration of the two companies	 Integrated HR management system in Japan Introduced online HR management system mainly in Japan Started selection of core HRs and their training Made succession plan and executed talent review in Japan Selected HR business 	•	 Establish global HR management system Introduce global hierarchy system Integrate MBO system Select candidates for core HRs and train them Succession plan/ Talent review Establish RHQ system 	•	Dynamic personnel composition suitable for the business speed Appointment of candidates for core managers ant their strategic training, and have pool of diversified talent Realize autonomous career development through establishment of global in- house recruitment system
(without online system)	ies	partners				©Resonac Corporation All Rights Reserved. 27

Cultivation of corporate culture that develops co-creative human resources

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Recognition of issues and results of our efforts

We are cultivating corporate culture where we can give free vent to each person's uncertain feelings ("moya-moya" in Japanese), have open discussion on them, and solve them together.

About 50% of employees practiced Purpose and Values in 2023 (up16 pt from 2022)

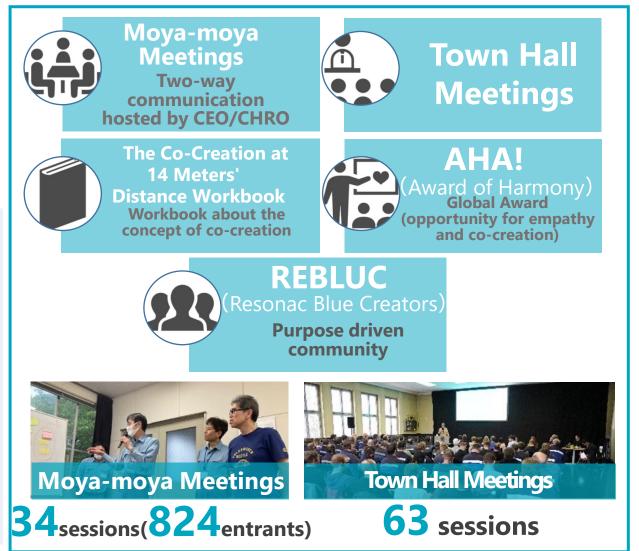
I felt safe because others sympathized with my moya-moya

Other sector's moyamoya made me aware of new issues



I was surprised when I found that there are opportunities to say what I think frankly to Takahashi-san and Imai-san

Specific measures (2023)

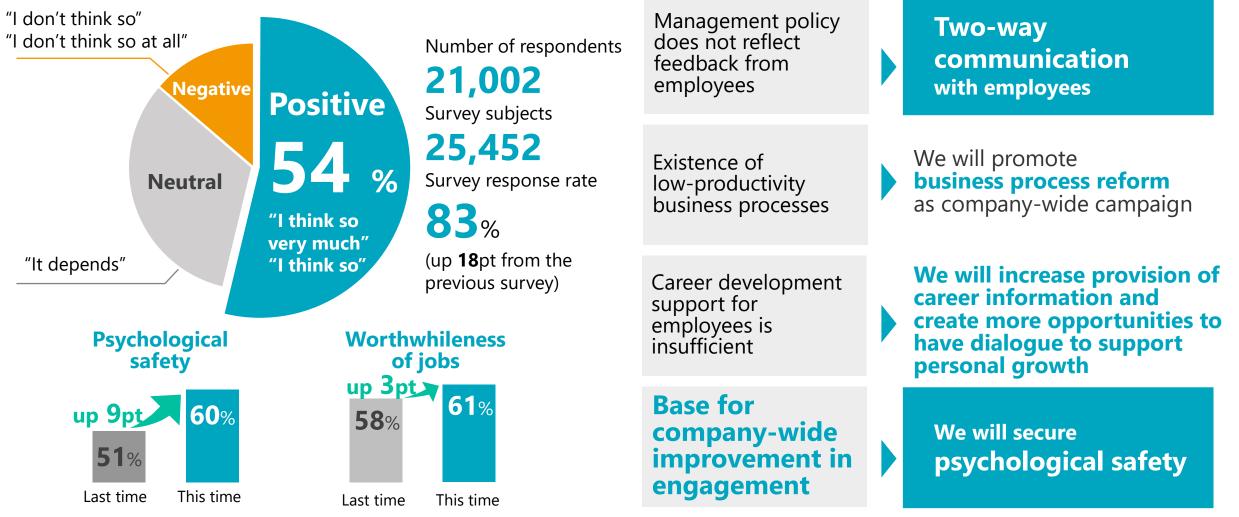


Two-way communication is the key: We will improve psychological safety further

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Engagement score

Actions to be taken



Previous survey: Sep. 2021, Survey of this time: July 2023

What we want to convey

Our target	Net sales over $¥1$ trillion	EBITDA 20%		PBR over 1 times			
Say & Do	Active investment in growin semiconductor materials busi Accelerate creation of co-creative innovation Corporate culture reform an Human resource developme		Make ope	ake the most of improvement in ket conditions and opportunities /lake operations more efficient otimization of business portfolio			
Present state	Net sales ¥1.3 trillion	EBITDA 8.2%		PBR 0.9 times			

RESONAC Chemistry for Change

<u>Note</u>

Performance forecast and other statements pertaining to the future as contained in this presentation are based on the information available as of today and assumptions as of today regarding risk factors that could affect our future performance. Actual results may differ materially from the forecast due to a variety of risk factors, including, but not limited to, the global political circumstances, the global economic conditions, tightening of regulations, demand for our products, market conditions, and foreign exchange rates. We undertake no obligation to update the forward-looking statements unless required by law.